

1.2A SURFACE MOUNT GLASS PASSIVATED BRIDGE RECTIFIER

Reverse Voltage - 100 to 1000 V

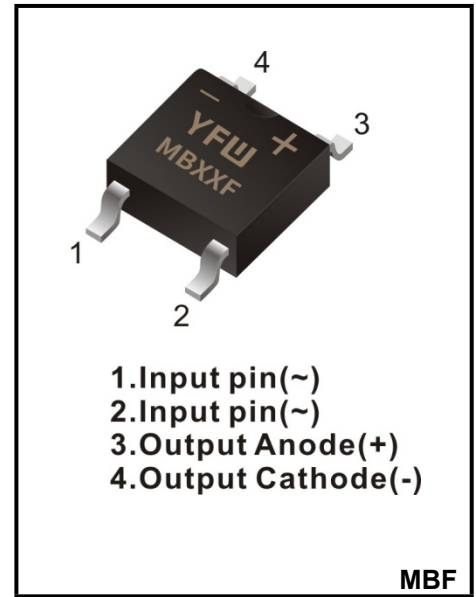
Forward Current - 1.2A

FEATURES

- ◆Glass Passivated Chip Junction
- ◆High Surge Current Capability
- ◆Designed for Surface Mount Application

MECHANICAL DATA

- ◆Case: MBF
- ◆Terminals: Solderable per MIL-STD-750, Method 2026
- ◆Approx. Weight: 75mg /0.0026oz



Maximum Ratings and Electrical characteristics

Ratings at 25 °C ambient temperature unless otherwise specified. Single phase half-wave 60 Hz, resistive or inductive load, for capacitive load current derate by 20 %.

Parameter	Symbols	MB1F-50	MB2F-50	MB4F-50	MB6F-50	MB8F-50	MB10F-50	Units
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	100	200	400	600	800	1000	V
Maximum RMS voltage	V_{RMS}	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V_{DC}	100	200	400	600	800	1000	V
Average Rectified Output Current at $T_C=125^{\circ}C$	I_o	1.2						A
Peak Forward Surge Current 8.3 ms Single Half Sine-Wave Superimposed on Rated Load(JEDEC method)	I_{FSM}	40						A
Forward Voltage per element at 1.2A	V_F	1.1						V
Maximum DC Reverse Current @ $T_A=25^{\circ}C$ at Rated DC Blocking Voltage @ $T_A=125^{\circ}C$	I_R	5 80						μA
Typical Junction Capacitance ^(Note1)	C_j	18						pF
Typical Thermal Resistance ^(Note2)	$R_{\theta JA}/R_{\theta JC}$	75 / 22						$^{\circ}C/W$
Operating and Storage Temperature Range	T_j, T_{stg}	-55 ~ +150						$^{\circ}C$

(1) Measured at 1 MHz and applied reverse voltage of 4 V D.C

(2) Mounted on glass epoxy PC board with 4×1.5"×1.5" (3.81×3.81 cm) copper pad.

Fig.1 Average Rectified Output Current Derating Curve

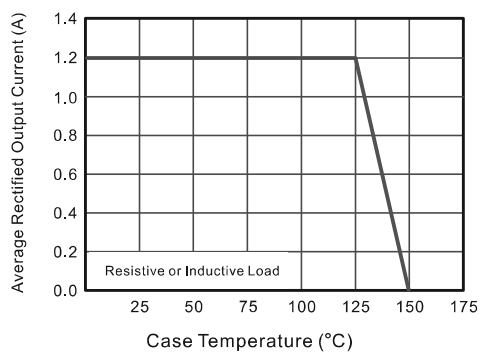


Fig.2 Typical Reverse Characteristics

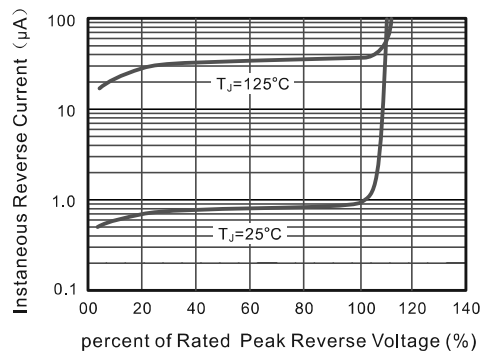


Fig.3 Typical Instantaneous Forward Characteristics

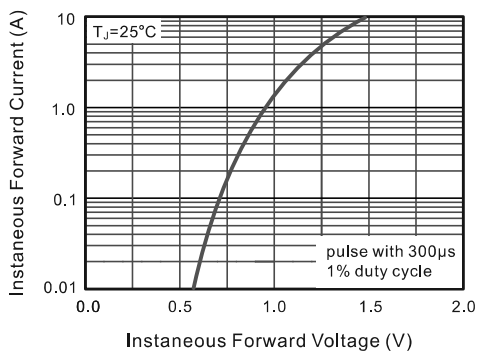


Fig.4 Typical Junction Capacitance

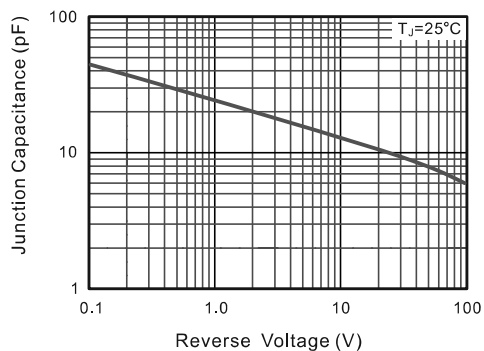
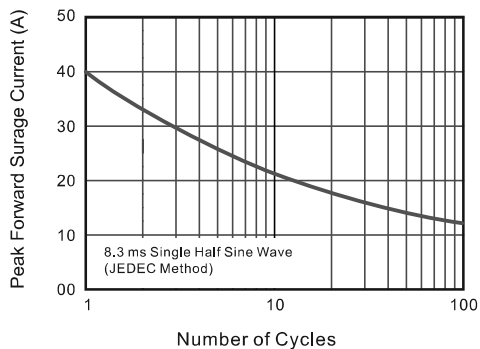
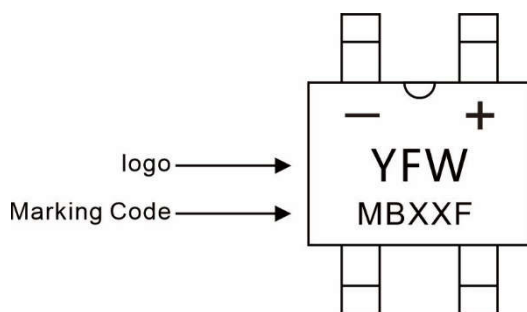


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current



Marking Diagram



Ordering information

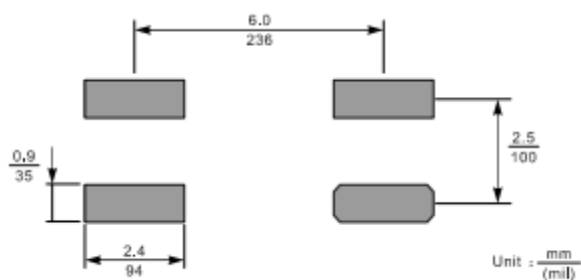
Package	Packing Description	Packing Quantity
MBF	Tape/Reel, 13" reel	5000PCS/Reel 50000PCS/Carton

Package Dimensions

MBF

Dim.	Millimeter(mm)		(mil)	
	Min.	Max.	Min.	Max.
A	1.2	1.6	51	59
C	0.15	0.22	5.9	8.7
D	4.5	5.0	193	205
E	3.6	4.1	166	177
HE	6.4	7.0	236	252
d	2.3	2.7	150	165
e	0.5	0.8	20	28
L	1.3	1.7	51	57
L1	0.5	1.1	20	43
a	/	0.2	/	8
∠	7°			

The recommended mounting pad size



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